



12V NPN HIGH GAIN POWER TRANSISTOR IN SOT23F

Features

- BV_{CEO} > 12V
- BV_{ECO} > 3V
- I_C = 4.5A Continuous Collector Current
- Low Saturation Voltage V_{CE(sat)} < 70mV @ 1A
- R_{CE(sat)} = 43mΩ
- 1.5W Power Dissipation
- Complementary PNP Type: ZXTP07012EFF
- Totally Lead-Free & Fully RoHS Compliant (Note 1&2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

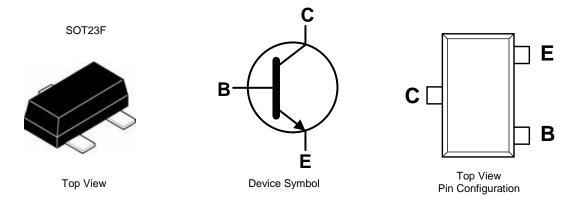
- Case: SOT23F
- Case Material: Molded Plastic. "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208[®]
- Weight: 0.012 grams (Approximate)

Description

This low voltage NPN transistor has been designed for applications requiring high gain and very low saturation voltage. The SOT23F package is pin compatible with the industry standard SOT23 footprint but offers lower profile and higher dissipation for applications where power density is of utmost importance.

Applications

- LED Driver
- Boost Converters
- Logic Interface
- Motor Drive



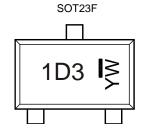
Ordering Information (Note 4)

Part number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN07012EFFTA	1D3	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



1D3 = Product Type Marking Code YW = Date Code Marking

Y = Year : 0~9

 \overline{W} = Week : A~Z : 1~26

a~z : 27~52

z represents 52 & 53 week



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	20	V
Collector-Emitter Voltage	V _{CEO}	12	V
Emitter-Collector Voltage (Reverse Blocking)	V _{ECO}	3	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	I _C	4.5	А
Peak Pulse Current	I _{CM}	10	А
Base Current	IB	1	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		0.84 6.72		
Power Dissipation	(Note 6)		1.34 10.72	W mW/°C	
Linear Derating Factor	(Note 7)	P _D	1.50 12.0		
	(Note 8)		2.0 16.0	1	
	(Note 5)	149			
The word Desistance I have then to Ambieut	(Note 6)		93	000	
Thermal Resistance, Junction to Ambient	(Note 7)	R _{θJA}	83	°C/W	
	(Note 8)		60		
Thermal Resistance, Junction to Lead (Note 9)		$R_{ heta JL}$	43.77	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 10)

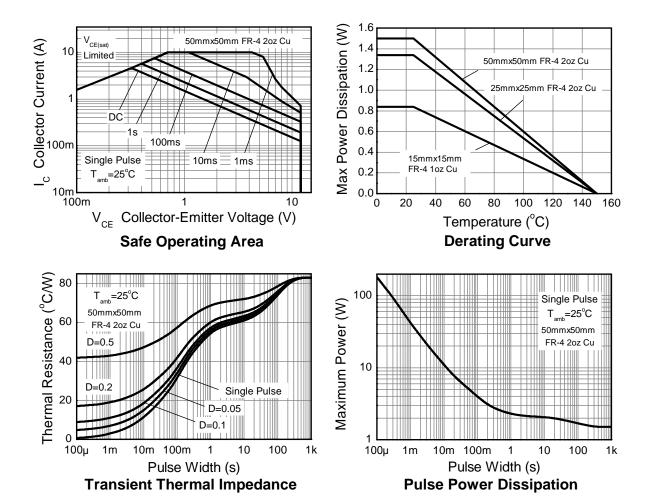
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
- 7. Same as Note 5, except the device is mounted on 50mm x 50mm 2oz copper.
- 8. Same as Note 7, whilst measured at t < 5 seconds.
- 9. Thermal resistance from junction to solder-point (at the end of the collector lead).
- 10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





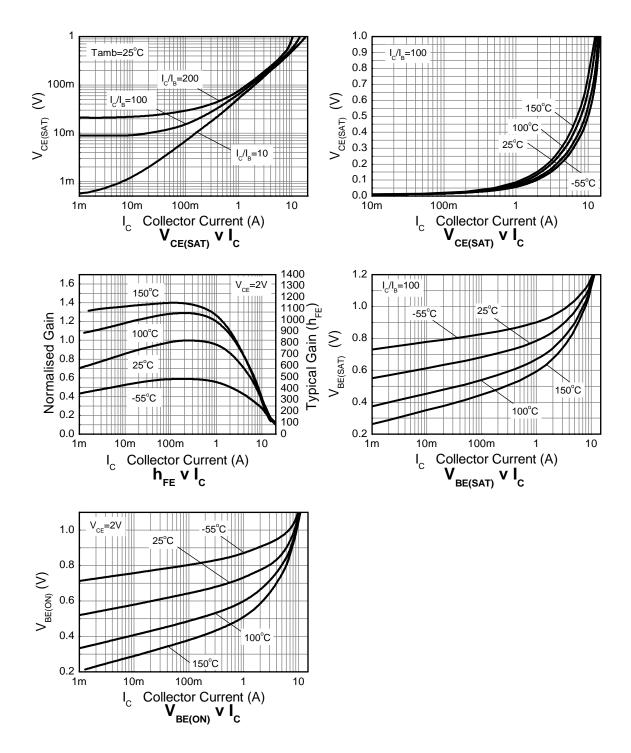
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	20	40	_	V	$I_C = 100\mu A$
Collector-Emitter Breakdown Voltage (Base Open) (Note 11)	BV _{CEO}	12	17	_	V	I _C = 10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.3	_	V	$I_{E} = 100 \mu A$
Emitter-Collector Breakdown Voltage (Reverse Blocking)	BV _{ECX}	6	8.2	_	V	I_E = 100μA; R_{BC} < 1k Ω or 0.25V < V_{BC} < -0.25V
Emitter-Collector Breakdown Voltage (Base Open)	BV _{ECO}	3	5.3	_	V	I _E = 100μA
Collector-Base Cut-Off Current	Ісво	_	<1 —	50 20	nΑ μΑ	V _{CB} = 16V V _{CB} = 16V, T _A = +100°C
Emitter-Base Cut-Off Current	I _{EBO}	_	<1	50	nA	V _{EB} = 5.6V
ON CHARACTERISTICS (Note 11)						. ==
Static Forward Current Transfer Ratio	hFE	500 400 330 140	800 650 530 230	1500 — — —	_	$\begin{split} I_{C} &= 100 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 2 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 4.5 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 10 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage	V _{CE} (sat)	_	25 60 50 105 215	40 85 70 150 320	mV	$I_C = 0.1A$, $I_B = 0.5mA$ $I_C = 1A$, $I_B = 10mA$ $I_C = 1A$, $I_B = 100mA$ $I_C = 2A$, $I_B = 20mA$ $I_C = 4.5A$, $I_B = 45mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	945	1050	mV	I _C = 4.5A, I _B = 45mA
Base-Emitter On Voltage	V _{BE(on)}	_	850	950	mV	I _C = 4.5A, V _{CE} = 2V
SMALL SIGNAL CHARACTERISTICS	1 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \					-
Transition Frequency	f⊤	150	220	_	MHz	$I_C = 50$ mA, $V_{CE} = 5V$, $f = 50$ MHz
Input Capacitance	C _{ibo}	_	229	_	pF	V _{EB} = 0.5V, f = 1MHz
Output Capacitance	C _{obo}	_	40	50	pF	V _{CB} = 10V, f = 1MHz
Delay Time	t _d	_	26.8	_	ns	101
Rise Time	t _r	_	14.2	_	ns	V _{CC} = 10V,
Storage Time	t _s	_	250	_	ns	$I_C = 500 \text{mA},$
Fall Time	t _f	_	67.7	_	ns	$I_{B1} = -I_{B2} = 50 \text{mA}$

Note: 11. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

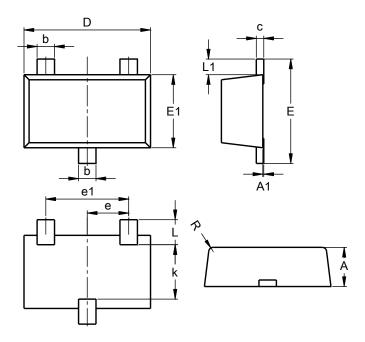




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23F

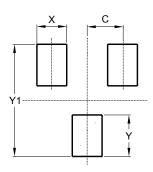


SOT23F						
Dim	Min	Max	Тур			
Α	0.80	1.00	0.90			
A1	0.00	0.10	0.01			
b	0.35	0.50	0.44			
U	0.10	0.20	0.16			
D	2.80	3.00	2.90			
e		0.95 RE	F			
e1		1.90 RE	F			
Е	2.30	2.50	2.40			
E1	1.50	1.70	1.65			
k	1.20					
١	0.30	0.65	0.50			
L1	0.30	0.50	0.40			
R	0.05	0.15	-			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23F



Dimensions	Value		
Dimensions	(in mm)		
С	0.95		
Х	0.80		
Y	1.110		
V1	3 000		



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2016, Diodes Incorporated

www.diodes.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Inc.:
ZXTN07012EFFTA